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Global X Exchange Traded Funds Series OFC* (the "Company")
(*This includes synthetic ETFs)

Global X Asia Semiconductor ETF
(Stock Code: 3119)
(the "Sub-Fund")

(Sub-fund of Global X Exchange Traded Funds Series OFC (*This includes synthetic ETFs), a Hong Kong public umbrella open-ended fund company with variable capital, limited liability and segregated liability between sub-funds and authorized under Section 104 of the Securities and Futures Ordinance (Cap. 571) of Hong Kong)*[1]

Announcement
Change to the index methodology of the Underlying Index of the Sub-Fund

Dear Shareholders,

We, as the Manager of the Company and the Sub-Fund, wish to inform Shareholders of the change to be made by FactSet Research Systems Inc. (the "Index Provider") to the index methodology of the FactSet Asia Semiconductor Index (the "Index"), the index of the Sub-Fund, which will take effect on 30 November 2026 (the "Effective Date").

1. Change to the Index

With effect from the Effective Date, the index methodology of the Index will be updated (the "Change") by the Index Provider. The Change is summarised below:

Area of change	Current Index methodology	Revised Index methodology
Index universe	Select securities classified to one of the following FactSet Revere Business Industry Classification Systems Focus at its Level 6 Sub-industries.	Select securities classified to one of the following FactSet Revere Business Industry Classification Systems Focus at its Level 6 Sub-industries.

[1] SFC authorisation is not a recommendation or endorsement of a scheme nor does it guarantee the commercial merits of a scheme or its performance. It does not mean the scheme is suitable for all investors nor is it an endorsement of its suitability for any particular investor or class of investors.

	• A.I./Large Scale Processing Graphics Controller • Assembly Equipment Manufacturing • Autonomous Vehicles Semiconductors • Computer/Gaming Graphics Accelerator/Controller • Conventional Flat Panel Display Equipment • Cryptomining Semiconductors • Data Center Graphics Accelerator/Controller • Diversified Semiconductor Capital Equipment Makers • Diversified Semiconductors • Flash Memory Semiconductors • General Analog and Mixed Signal Semiconductors • General Automotive Semiconductors • General Graphics Accelerator/Controller • Handheld Graphics Accelerator/Controller • Image Sensor and Image Capture Semiconductors • Light Emitting Diode Discrete Semiconductors • Multimedia Semiconductors • Other Discrete Semiconductors • Other Front-End Processing Equipment Makers** • Other Interconnect Fabrication Services • Other Memory Semiconductors • Other Power Analog and Mixed Signal Semiconductors • Other Processor Semiconductors • Quantum Processor Semiconductors • RF Analog and Mixed Signal Semiconductors • Security and Identification Semiconductors • Semiconductor Foundry Services • Semiconductor packaging and Testing Services • Specialty Analog and Mixed Signal Semiconductors • Test, Measurement and Metrology Equipment Makers	• **A.I./Data Center/Large Scale Processing GPU** • Assembly Equipment Manufacturing • Autonomous Vehicles Semiconductors • Computer/Gaming Graphics Accelerator/Controller • Conventional Flat Panel Display Equipment • Cryptomining Semiconductors • Data Center Graphics Accelerator/Controller • Diversified Semiconductor Capital Equipment Makers • Diversified Semiconductors • Flash Memory Semiconductors • General Analog and Mixed Signal Semiconductors • General Automotive Semiconductors • General Graphics Accelerator/Controller • Handheld Graphics Accelerator/Controller • Image Sensor and Image Capture Semiconductors • Light Emitting Diode Discrete Semiconductors • Multimedia Semiconductors • Other Discrete Semiconductors • Other Front-End Processing Equipment Makers** • Other Interconnect Fabrication Services • Other Memory Semiconductors • Other Power Analog and Mixed Signal Semiconductors • Other Processor Semiconductors • Quantum Processor Semiconductors • RF Analog and Mixed Signal Semiconductors • Security and Identification Semiconductors • Semiconductor Foundry Services • Semiconductor packaging and Testing Services • Specialty Analog and Mixed Signal Semiconductors • Test, Measurement and Metrology Equipment Makers • Turnkey Assembly Manufacturing Services

Area of change	Current Index methodology	Revised Index methodology
	• Turnkey Assembly Manufacturing Services • Volatile Memory Semiconductors • Wafer Blank Makers and Equipment Manufacturing** • Photolithography Equipment Manufacturing *** For companies that are either classified as 'Other Front-End Processing Equipment Makers' or 'Wafer Blank Makers and Equipment Manufacturing', exclude those that are mapped to 'Photovoltaic Wafers' in Revere Hierarchy.*	• Volatile Memory Semiconductors • Wafer Blank Makers and Equipment Manufacturing** • Photolithography Equipment Manufacturing *** For companies that are either classified as 'Other Front-End Processing Equipment Makers' or 'Wafer Blank Makers and Equipment Manufacturing', exclude those that are mapped to 'Photovoltaic Wafers' in Revere Hierarchy.*

2. Impact on the Sub-Fund

There will be no change to the fee level or cost in managing the Sub-Fund following the implementation of the Change.

Save as otherwise set out above, there will be no impact on the operation and/or manner in which the Sub-Fund is being managed and the Change will not affect the existing Investors of the Sub-Fund, and there will be no change to the features or risk profile of the Sub-Fund. The Investors' rights or interests will not be materially prejudiced as a result of the Change set out in this Announcement.

The Change described in this Announcement does not require investors' approval.

3. General

Unless otherwise stated, all capitalised terms in this Announcement shall have the same meaning as in the Prospectus of the Company (the "Prospectus") dated 2 November 2026.

The Prospectus will be updated to reflect the above Change as well as consequential changes, editorial and miscellaneous updates. The updated Prospectus will be available on the Manager's website at https://www.globalxetfs.com.hk/[2] and the HKEX's website at www.hkex.com.hk on or around 30 November 2026.

Investors who have any enquiries regarding the above may contact the Manager, Mirae Asset Global Investments (Hong Kong) Limited, at Room 1101, 11/F, Lee Garden Three, 1 Sunning Road, Causeway Bay, Hong Kong or our enquiry hotline at (852) 2295-1500 during office hours.

Mirae Asset Global Investments (Hong Kong) Limited
as the Manager of the Company and Sub-Fund
Date: 23 November 2026

[2]This website has not been reviewed by the SFC.